Date: April 14, 2004

Group Art Unit: 2829

Examiner: V. P. Nguyen

Docket No.: YO993-028BX

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APR 1 4 2004

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Applicants:

Beaman et al.

Serial No.: 09/382,834

Filed: August 25, 1999

HIGH DENSITY INTEGRATED CIRCUIT APPARATUS,

TEST PROBE AND METHODS OF USE THEREOF

**Commissioner for Patents** P.O. Box 1450 Alexandria, VA 22313-1450

## CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this Response to Office Communication dated 4/8/2004 (2 pages) is being facsimile transmitted to the U.S. Patent and Trademark Office to (703) 872-9306 on April 14, 2004.

Dr. Daniel P. Morris, Esq.

Reg. No. 32,053

## REMARKS

In response to Office Communication dated April 8, 2004, please consider the following:

## REMARKS

Claims 29-64 have been rejected under 35 USC 102(b) as anticipated by U.S. Patent 5,371,654.

As amended at page 3 of Applicants' response submitted 03-08-2004, the present application is a CIP of U.S. Patent 5,371,654 and incorporates the entire teaching thereof. Thus, U.S. Patent 5,371,654 cannot be an anticipation under 35 USC 102.

Please charge any fee necessary to enter this paper and any previous paper to deposit account 09-0468.

Respectfully submitted,

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